



Parameter	Rating	Units
Blocking Voltage	60	V <sub>P</sub>
Load Current	4	A <sub>DC</sub>
On-Resistance	0.09	Ω

## Features

- Handle Load Currents Up to 4A<sub>DC</sub>
- 2500V<sub>rms</sub> Input/Output Isolation
- Power SIP Package
- High Reliability
- No Moving Parts
- Low Drive Power Requirements (TTL/CMOS Compatible)
- Arc-Free With No Snubbing Circuits
- No EMI/RFI Generation
- Machine Insertable, Wave Solderable

## Applications

- Industrial Controls
- Motor Control
- Robotics
- Medical Equipment—Patient/Equipment Isolation
- Instrumentation
  - Multiplexers
  - Data Acquisition
  - Electronic Switching
  - I/O Subsystems
  - Meters (Watt-Hour, Water, Gas)
- IC Equipment
- Home Appliances

## Description

Clare and IXYS have combined to bring OptoMOS® technology, reliability, and compact size to a new family of high power solid state relays. The CPC1706, a DC-switching, normally open (1-Form-A) Solid State Relay, is part of that family.

Employing optically coupled MOSFET technology, the CPC1706 provides 2500V<sub>rms</sub> of input to output isolation. The efficient MOSFET switches and photovoltaic die use Clare's patented OptoMOS architecture, while the highly efficient GaAlAs infrared LED provides the optically coupled control.

The combination of low on-resistance and high load current handling capability makes this relay suitable for a variety of high performance switching applications.

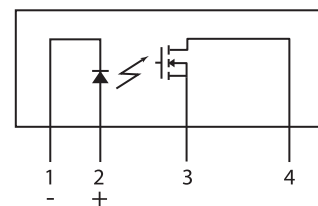
## Approvals

- UL 508 Certified Component: File E69938
- CSA Certified Component: Certificate 1172007

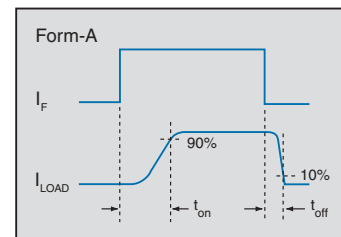
## Ordering Information

Part #	Description
CPC1706Y	4-Pin (8-Pin Body) Power SIP Package (25 per tube)

## Pin Configuration



## Switching Characteristics of Normally Open Devices



## Absolute Maximum Ratings @ 25°C

Parameter	Min	Max	Units
Blocking Voltage	-	60	V <sub>P</sub>
Reverse Input Voltage	-	5	V
Input control Current	-	50	mA
Peak (10ms)	-	1	A
Input Power Dissipation <sup>1</sup>	-	150	mW
Total Power Dissipation <sup>2</sup>	-	1600	mW
Isolation Voltage, Input to Output	-	2500	V <sub>rms</sub>
Operational Temperature	-40	+85	°C
Storage Temperature	-40	+125	°C

<sup>1</sup> Derate linearly 3.33 mW / °C

<sup>2</sup> Derate linearly 16.667 mW / °C

*Absolute Maximum Ratings are stress ratings. Stresses in excess of these ratings can cause permanent damage to the device. Functional operation of the device at conditions beyond those indicated in the operational sections of this data sheet is not implied.*

## Electrical Characteristics @ 25°C

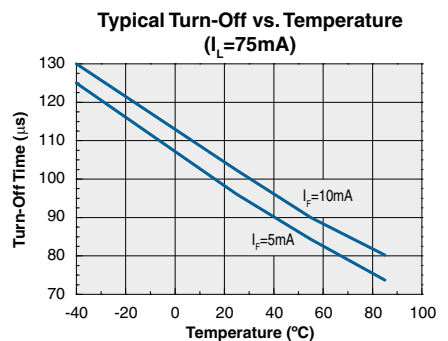
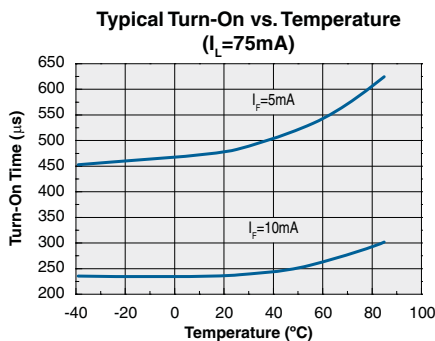
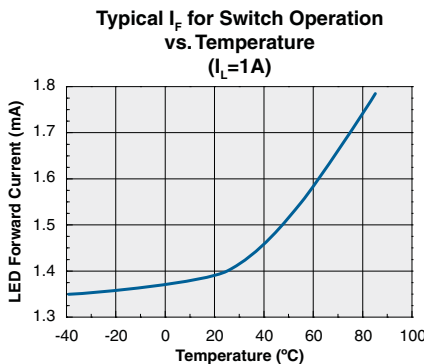
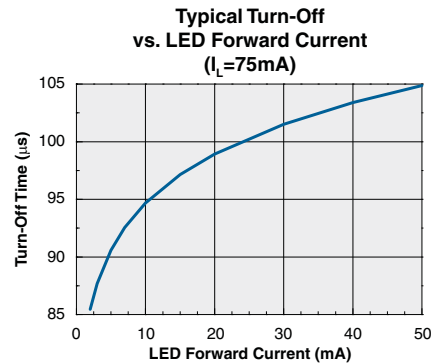
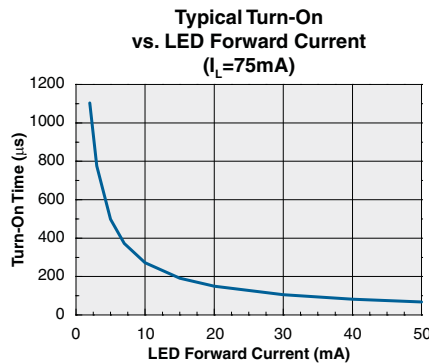
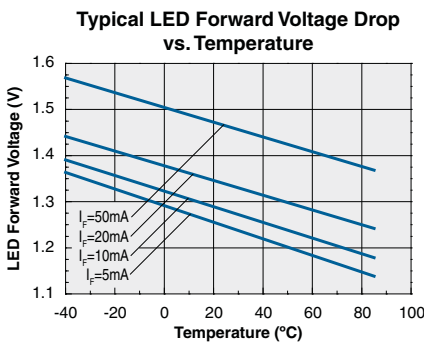
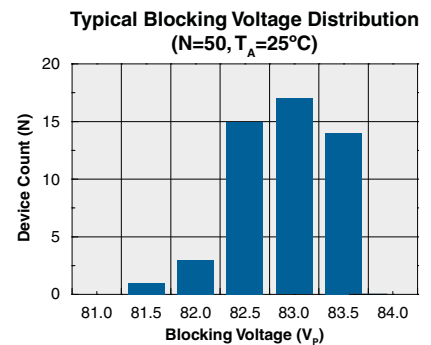
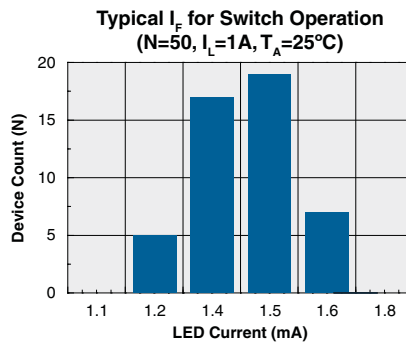
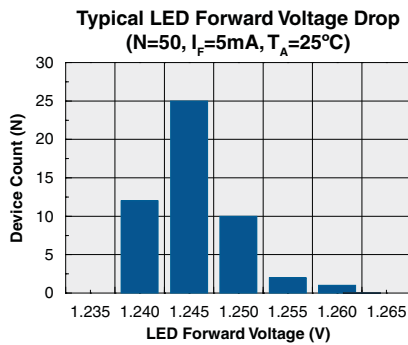
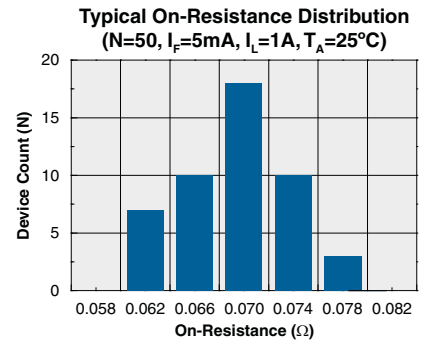
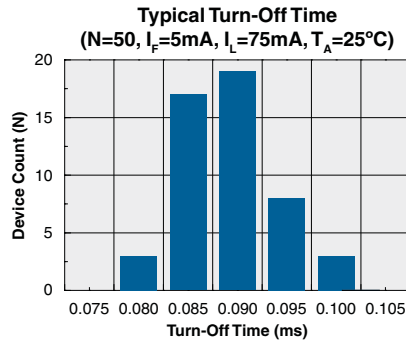
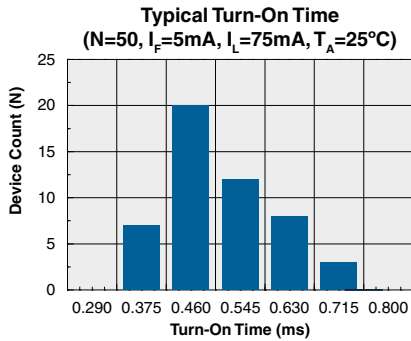
Parameter	Conditions	Symbol	Min	Typ	Max	Units
<b>Output Characteristics</b>						
Load Current, Continuous	I <sub>F</sub> =5mA, Free air	I <sub>L</sub>	-	-	4	A <sub>DC</sub>
Peak Load Current	I <sub>F</sub> =5mA, t=10ms	I <sub>LPK</sub>	-	-	9	A
On-Resistance <sup>1</sup>	I <sub>F</sub> =5mA, I <sub>L</sub> =1A	R <sub>ON</sub>	-	0.07	0.09	Ω
Off-State Leakage Current	I <sub>F</sub> =0mA, V <sub>L</sub> =60V <sub>P</sub>	I <sub>LEAK</sub>	-	-	1	μA
Switching Speeds	I <sub>F</sub> =5mA, V <sub>L</sub> =10V	t <sub>on</sub>	-	0.5	5	ms
Turn-On						
Turn-Off		t <sub>off</sub>	-	0.085	2	
Output Capacitance	I <sub>F</sub> =0mA, V <sub>L</sub> =50V, f=1MHz	C <sub>OUT</sub>	-	75	-	pF
<b>Input Characteristics</b>						
Input Control Current	I <sub>L</sub> =1A	I <sub>F</sub>	-	1.4	5	mA
Input Dropout Current	-	I <sub>F</sub>	0.4	-	-	mA
Input Voltage Drop	I <sub>F</sub> =5mA	V <sub>F</sub>	0.9	1.2	1.4	V
Reverse Input Current	V <sub>R</sub> =5V	I <sub>R</sub>	-	-	10	μA
<b>Input/Output Characteristics</b>						
Capacitance Input/Output	f=1MHz	C <sub>IO</sub>	-	2	-	pF

<sup>1</sup> Measurement taken within 1 second of on-time.

## Thermal Characteristics

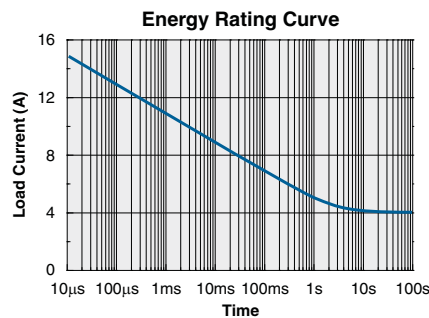
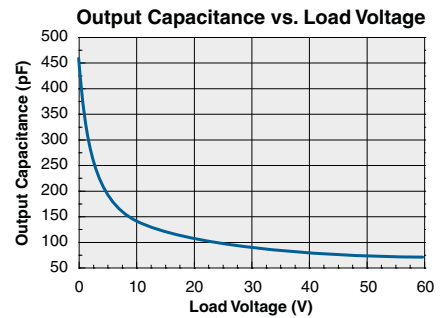
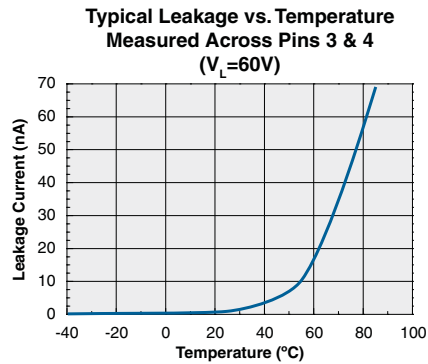
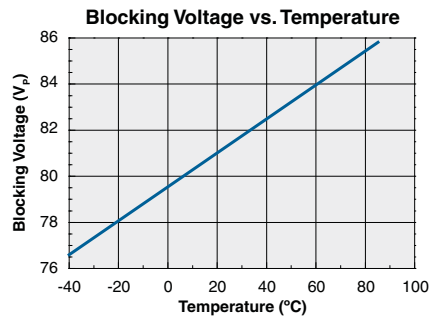
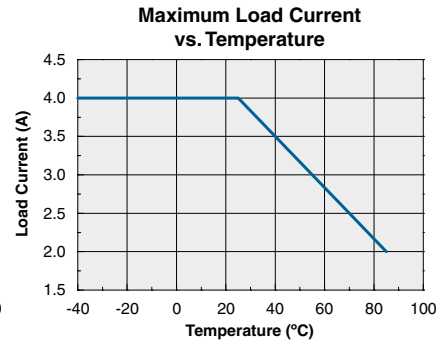
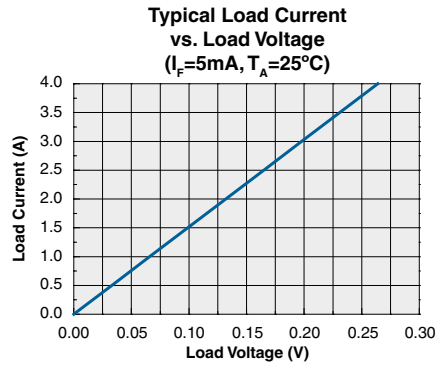
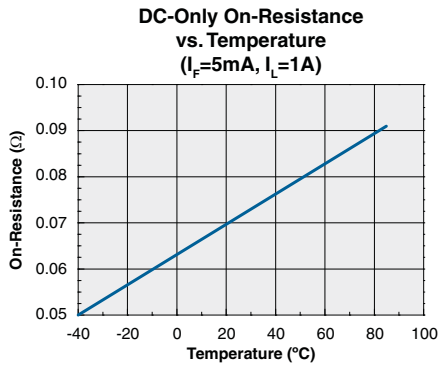
Parameter	Conditions	Symbol	Min	Typ	Max	Units
Thermal Resistance (junction to case)	-	R <sub>θJC</sub>	-	1.5	-	°C/W

**PERFORMANCE DATA\***



\* The Performance data shown in the graphs above is typical of device performance. For guaranteed parameters not indicated in the written specifications, please contact our application department.

**PERFORMANCE DATA\***



\* The Performance data shown in the graphs above is typical of device performance. For guaranteed parameters not indicated in the written specifications, please contact our application department.

## Manufacturing Information

### Moisture Sensitivity



All plastic encapsulated semiconductor packages are susceptible to moisture ingress. Clare classified all of its plastic encapsulated devices for moisture sensitivity according to the latest version of the joint industry standard, **IPC/JEDEC J-STD-020**, in force at the time of product evaluation. We test all of our products to the maximum conditions set forth in the standard, and guarantee proper operation of our devices when handled according to the limitations and information in that standard as well as to any limitations set forth in the information or standards referenced below.

Failure to adhere to the warnings or limitations as established by the listed specifications could result in reduced product performance, reduction of operable life, and/or reduction of overall reliability.

This product carries a **Moisture Sensitivity Level (MSL) rating** as shown below, and should be handled according to the requirements of the latest version of the joint industry standard **IPC/JEDEC J-STD-033**.

Device	Moisture Sensitivity Level (MSL) Rating
CPC1706Y	MSL 1

### ESD Sensitivity



This product is **ESD Sensitive**, and should be handled according to the industry standard **JESD-625**.

### Reflow Profile

This product has a maximum body temperature and time rating as shown below. All other guidelines of **J-STD-020** must be observed.

Device	Maximum Temperature x Time
CPC1706Y	245°C for 30 seconds

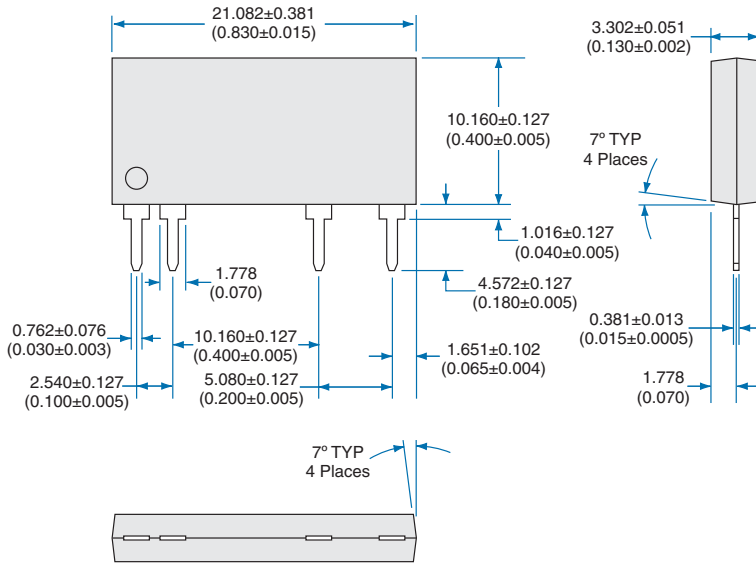
### Board Wash

Clare recommends the use of no-clean flux formulations. However, board washing to remove flux residue is acceptable. Since Clare employs the use of silicone coating as an optical waveguide in many of its optically isolated products, the use of a short drying bake could be necessary if a wash is used after solder reflow processes. Chlorine- or Fluorine-based solvents or fluxes should not be used. Cleaning methods that employ ultrasonic energy should not be used.

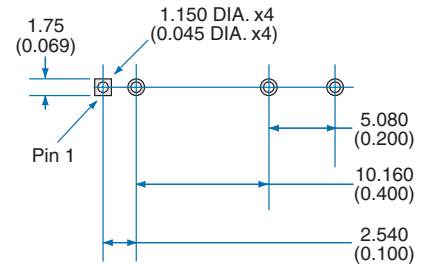


**MECHANICAL DIMENSIONS**

**Manufacturing Information**



**PCB Hole Pattern**



Dimensions  
mm  
(inches)

**For additional information please visit our website at: [www.clare.com](http://www.clare.com)**

Clare, Inc. makes no representations or warranties with respect to the accuracy or completeness of the contents of this publication and reserves the right to make changes to specifications and product descriptions at any time without notice. Neither circuit patent licenses nor indemnity are expressed or implied. Except as set forth in Clare's Standard Terms and Conditions of Sale, Clare, Inc. assumes no liability whatsoever, and disclaims any express or implied warranty, relating to its products including, but not limited to, the implied warranty of merchantability, fitness for a particular purpose, or infringement of any intellectual property right.

The products described in this document are not designed, intended, authorized or warranted for use as components in systems intended for surgical implant into the body, or in other applications intended to support or sustain life, or where malfunction of Clare's product may result in direct physical harm, injury, or death to a person or severe property or environmental damage. Clare, Inc. reserves the right to discontinue or make changes to its products at any time without notice.

Specification: DS-CPC1706-R02  
©Copyright 2010, Clare, Inc.  
OptoMOS® is a registered trademark of Clare, Inc.  
All rights reserved. Printed in USA.  
11/1/2010